

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

July 23, 2004

In re application of

GUO, Ying

Serial No.

10/008,740

Filed

November 13, 2001

Invention

IMPROVED BICOMPONENT

FILAMENT SPIN PACK USED IN

**SPUNBOND PROCESS** 

Examiner:

Edwards, Laura Estelle

Art Unit

1734

Our File No.

8988.3827

## **AMENDMENT**

Mail Stop Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Examiner's Office Action of February 24, 2004, this amendment is submitted. Reconsideration is respectfully requested. A two month request for an extension of time is enclosed extending the time to respond to July 24, 2004. This application was subject to an Election Requirement by the Examiner.

Group I., Claims 1-7 drawn to a spin pack assembly, classified in class 425, subclass 463 was elected by the applicant. Claims 8 and 9 drawn to a spin pack housing, classified in class 425, subclass 131.5 was not elected. Claims 10-13 were drawn to a method of

In re application of: GUO, Ying

Serial No.: 10/008,740

Page 2

distributing polymer, classified in class 264, subclass 172.11. These claims were not elected.

In summary, applicant hereby affirms the election of Group I., Claims 1-7. Claims 8-13 are withdrawn from further consideration.

Please amend the application as follows:

The Claims, as amended, are shown on pages 3 through 8.

The Remarks are shown on pages 9 through 12.